

Chip beads

For general signal line

MMZ series

MMZ0402 type

MMZ0402

0402[01005 inch]*

* Dimensions Code JIS[EIA]

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

⚠ REMINDERS
The storage period is less than 12 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C, Humidity: 10 to 75% RH or less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
○ Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
Carefully lay out the coil for the circuit board design of the non-magnetic shield type. A malfunction may occur due to magnetic interference.
Use a wrist band to discharge static electricity in your body through the grounding wire.
On not expose the products to magnets or magnetic fields.
On not use for a purpose outside of the contents regulated in the delivery specifications.
The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition. The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.
If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions

- (1) Aerospace/Aviation equipment
- (2) Transportation equipment (cars, electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment

set forth in the each catalog, please contact us.

- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.



Chip beads

For general signal line

Product compatible with RoHS directive
Halogen-free
Compatible with lead-free solders

Overview of MMZ0402 type

FEATURES

- O Noise reduction solution for general signal line.
- Various frequency characteristics with 4 materials of different features for countermeasures against everything from general signals to high-speed signals.

APPLICATION

- O Noise removal for mobile devices such as smartphones and tablet terminals, and various modules.
- O Noise removal for PCs and recorders, household appliances such as STBs, smart grids, and industrial equipment.

PART NUMBER CONSTRUCTION

MMZ	0	402	S	100		С		T		000		00
Series name	L×W×T Dimensions (mm)		Material name	Impedance (Ω) at 100MHz		Charac	teristic pe	Pacl	Packaging style		Internal code	
	0402	0.4×0.2x0.2	D	100	10)	Т	Taping	000	W8P2	Paper carrier
			S	121	120	-				F0W	W4P1	Plastic carrier
			Y									
			EUC									

■ OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

	Temperat	ure range	Package quantity	Individual weight	
Туре	Operating Storage temperature*				
	(°C)	(°C)	(pieces/reel)	(mg)	
MMZ0402**T000			20,000	_	
(W8P2 Paper carrier)	-55 to +125	-55 to +125	20,000	0.08	
MMZ0402**TF0W (W4P1 Plastic carrier)	-55 to +125	-55 to +125	40,000	0.00	

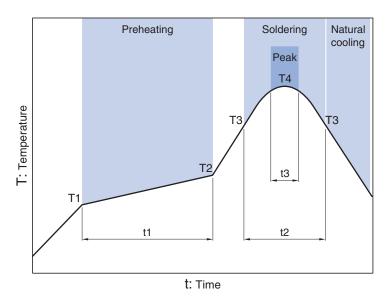
^{*} The Storage temperature range is for after the circuit board is mounted.

RoHS Directive Compliant Product: See the following for more details.https://product.tdk.com/info/en/environment/rohs/index.html

O Halogen-free: Indicates that CI content is less than 900ppm, Br content is less than 900ppm, and that the total CI and Br content is less than 1500ppm.



■ RECOMMENDED REFLOW PROFILE



Preheati	ng		Soldering	I	Peak	
Temp.		Time	Temp.	Time	Temp.	Time
T1	T2	t1	Т3	t2	T4	t3
150°C	180°C	60 to 120s	230°C	30 to 60s	250 to 260°C	10s



MATERIAL CHARACTERISTICS

S material: Standard type that features impedance characteristics similar to those of a typical ferrite core. For signal line applications in which the blocking region is near 100MHz. Impedance values selected for effectiveness at 40 to 300MHz.

Y material: High frequency range type intended for the 100MHz region and above.

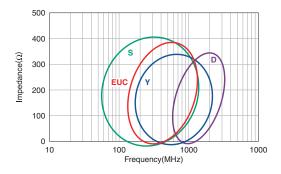
For signal line applications in which the signal frequency is far from the cutoff frequency. Impedance values selected for effectiveness at 80 to 400MHz.

D material: For applications calling for low insertion loss at low frequencies and sharply increasing impedance at high frequencies.

Designed for high impedance at high frequencies (300MHz to 1GHz) for signal line applications.

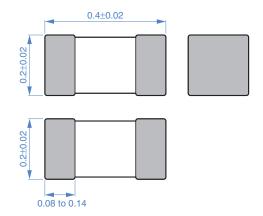
EUC material: Broadband response, low resistance type for 100MHz near more bandwidth. In order to achieve a high impedance in cellular band is ideal for reception sensitivity.

TYPICAL MATERIAL IMPEDANCE CHARACTERISTICS





■SHAPE & DIMENSIONS





Dimensions in mm

■ RECOMMENDED LAND PATTERN



Dimensions in mm



■ ELECTRICAL CHARACTERISTICS

□ CHARACTERISTICS SPECIFICATION TABLE

Impedance		DC resistance	Rated current	Part No.
[100MHz]				
(Ω)	Tolerance	(Ω)max.	(mA)max.	
10	$\pm 5\Omega$	0.07	750	MMZ0402S100CT000
70	±25%	0.36	300	MMZ0402S700CT000
120	±25%	0.70	210	MMZ0402S121CT000
150	±25%	0.70	200	MMZ0402S151CT000
240	±25%	1.00	200	MMZ0402S241CT000
150	±25%	0.62	350	MMZ0402EUC151CTF0W
180	±25%	0.69	300	MMZ0402EUC181CTF0W
75	±25%	0.70	250	MMZ0402Y750CT000
150	±25%	0.69	200	MMZ0402Y151CT000
22	±25%	0.70	250	MMZ0402D220CT000

O Measurement equipment

Measurement item	Product No.	Manufacturer
Impedance	E4991A+16196D	Keysight Technologies
DC resistance	Type-7556	Yokogawa

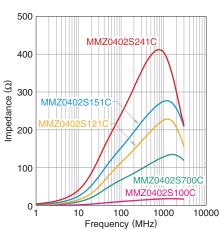
^{*} Equivalent measurement equipment may be used.



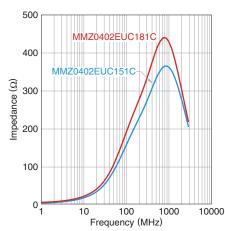
■ ELECTRICAL CHARACTERISTICS

□ Z VS. FREQUENCY CHARACTERISTICS (BY SERIES)

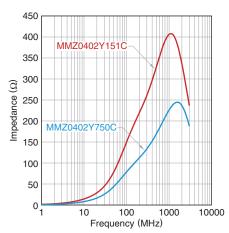
MMZ0402S SERIES



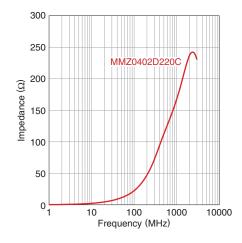
MMZ0402EUC SERIES



MMZ0402Y SERIES



MMZ0402D SERIES

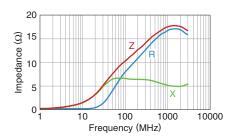




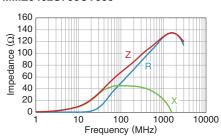
ELECTRICAL CHARACTERISTICS

Z, X, R VS. FREQUENCY CHARACTERISTICS

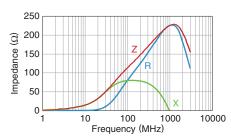
MMZ0402S100CT000



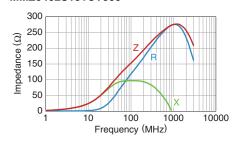
MMZ0402S700CT000



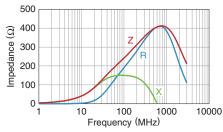
MMZ0402S121CT000



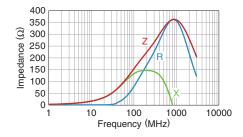
MMZ0402S151CT000



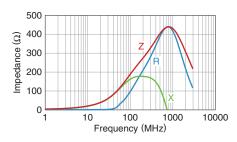
MMZ0402S241CT000



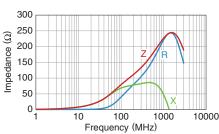
MMZ0402EUC151CTF0W



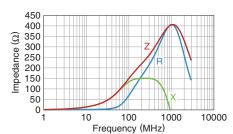
MMZ0402EUC181CTF0W



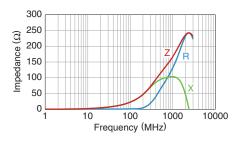
MMZ0402Y750CT000



MMZ0402Y151CT000



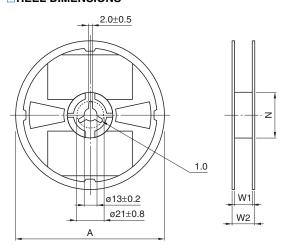
MMZ0402D220CT000



Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

■PACKAGING STYLE

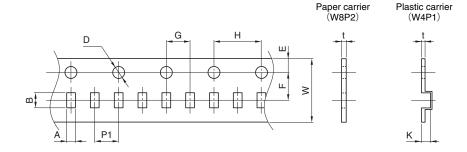
□REEL DIMENSIONS



Dimensions in mm

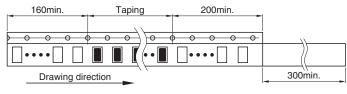
Туре	Package specifications	Α	W1	W2	N
MMZ0402**T000	Paper carrier (W8P2)	ø180±2.0	8.4+2.0, -0.0	14.4max.	ø60min.
MMZ0402**TF0W	Plastic carrier (W4P1)	ø178±2.0	5.0±1.0	_	ø60±2.0

TAPE DIMENSIONS



Dimensions in mm

Type	Package specifications	W	P1	Α	В	D	Е	F	G	Н	t	K
MMZ0402	(M8P2)	8.0±0.3	2.0±0.05	0.26±0.04	0.46±0.04	1.55±0.02	1.75±0.03	3.50±0.05	2.0±0.05	4.0±0.10	0.4max.	_
	Plastic carrier (W4P1)	4.0±0.1	1.0±0.04	0.24±0.04	0.44±0.04	0.80±0.08	0.90±0.10	1.80±0.04	1.0±0.04	2.0±0.08	0.3max.	0.29max.



Dimensions in mm